

### **BME 202 Electronics**

#### Lecture 1: Semiconductor Diodes

## Semiconductor Materials



- Conductors electrical charge carriers move easily when a voltage is applied
- Insulators a material of very low conductivity, in which electrical charge carriers can not easily move
- Semiconductors a special class of elements having a conductivity between that of a conductor and insulator.

most frequently use semiconductors in electronic circuits: *Ge*, *Si*, and *GaAs* 

#### **Atomic Structure**



- electron, proton, and neutron
- atomic structure and crystalline formation
- Bohr model
- valence electrons

	# of electrons	# of valence electrons	
Silicon	14	4	tetravalent
Germanium	32	4	tetravalent
Gallium	31	3	trivalent
Arsenic	33	5	pentavalent

# **Covalent Bonding and Intrinsic Materials**



- covalent bonding: bonding of atoms sharing valence electrons
- stronger than the bond between the valence electron and the parent atom
- can go into free state when enough kinetic energy is applied
- intrinsic: any semiconductor material that has been carefully refined to reduce the number of impurities to a very low level

## Intrinsic Carriers and Mobility Factor



Semiconductor	n <sub>i</sub> Intrinsic Carriers (per cm³)	
GaAs	1.7 x 10 <sup>6</sup>	
Si	1.5 x 10 <sup>10</sup>	
Ge	2.5 x 10 <sup>13</sup>	

Semiconductor	$\mu_n$ Relative Mobility Factor (cm $^2/ extsf{V}\cdot extsf{s}$ )
Si	1500
Ge	3900
GaAs	8500

 doping: changing the characteristic of the material by adding proper type of impurity in controlled amounts

# Intrinsic Carriers and Mobility Factor



- doping: changing the characteristic of the material by adding proper type of impurity in controlled amounts
- reaction to heat: semiconductors have negative temperature coefficient (i.e. more valence electrons can break the covalent bond and contribute to the number of free carriers increasing the conductivity)
- note that, conductors have positive temperature coefficient (i.e. Increased resistance due to vibrating electrons)

# **Energy Levels**



- specific energy level associated with each shell and orbiting electron
- discrete energy levels
- the farther an electron is from the nucleus, the higher the energy level
- any electron that has left its parent atom has an energy state higher than any electron in the atomic structure
- conduction band, valence band, energy gaps

#### **Extrinsic Materials**



 extrinsic material: a semiconductor material that has been subjected to doping.

#### n-Type

- silicon or germanium base
- pentavalent impurity elements (eg. Sb, Ar, Ph)
- 4 covalent bonds, 5th electron usassociated with any covalent bond
- donor atoms
- still neural!!!
- majority carrier is the electron

#### p-Type

- silicon or germanium base
- tetravalent impurity elements (eg. B, Ga, In)
- 3 covalent bonds, one vacancy → hole
- acceptor atoms
- still neural!!!
- majority carrier is the hole

electron flow vs hole flow conventional flow  $\rightarrow$  direction of the hole flow

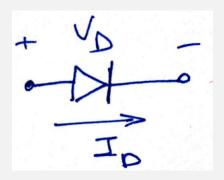
## Semiconductor Diodes



- bring n-type and p-type materials together
- a two terminal device is formed
- a depletion region is formed near the junction

# No Applied Bias

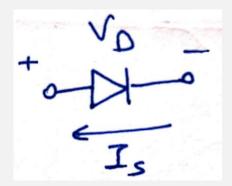




• in the absence of an applied bias voltage, the net flow of charge in any one direction for a semiconductor diode is zero

### **Reverse-Bias Condition**



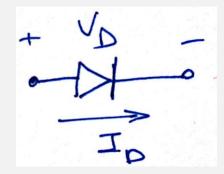


- An external voltage is applied across the junction such that the positive terminal is connected to the n-type material and the negative terminal is connected to the p-type material.
- The current that exists under reverse-bias conditions is called the *reverse saturation current* and is represented by  $I_S$ .
- Reverse saturation current is in the order of a few microamperes and does not change significantly with the increase in reverse-bias potential.

### Forward-Bias Condition



 Apply positive potential to the p-type material and negative potential to the n-type material.



- The width of the depletion region is reduced.
- The voltage rises quickly and stays at around a value less than 1V and the current value depends on the applied external voltage and other circuit parameters.

### Forward-Bias Condition



The point at which the diode changes from no-bias condition to forward-bias condition occurs when the electrons and holes are given sufficient energy to cross the p-n junction. This energy comes from the external voltage applied across the diode.

The forward bias voltage required for a:

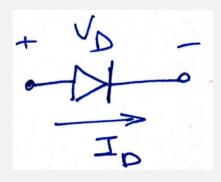
gallium arsenide diode ≅ 1.2 V

silicon diode  $\approx 0.7 \text{ V}$ 

germanium diode ≅ 0.3 V

#### Ideal Diode Characteristics





A diode ideally conducts in only one direction.

#### **Conduction Region**

The voltage across the diode is 0 V The current is infinite The diode acts like a short

#### Non-Conduction Region

All of the voltage is across the diode The current is 0 A The diode acts like open

## **Diode Characteristics**



#### Shockley's equation

$$I_D = I_S \left( e^{V_D/nV_T} - 1 \right) (A)$$

 $I_{\rm S}$  : reverse saturation current

 $V_{D}\;\;$  : applied forward-bias voltge across the diode

ideality factor, which is a function of the operating conditions and

physical construction (between 1 and 2)

 $V_T$ : thermal voltage

$$V_T = \frac{kT_K}{q} \text{ (V)}$$

k: Boltzman's constant = 1.38 x 10<sup>-23</sup> J/K

 $T_K$ : absolute temperature in kelvins = 273 + the temp in  $C^{\circ}$ 

q: magnitude of electronic charge =  $1.6 \times 10^{-19} \,\mathrm{C}$